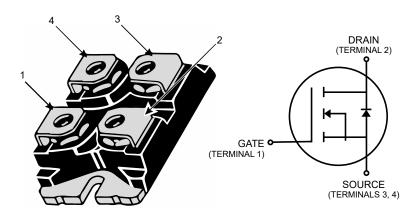
1200V, 80 mΩ N-Channel mSiC™ MOSFET

MSC080SMA120J



Product Overview

1200V, 80 m Ω typical at V_{GS} = 20V, 90 m Ω typical at V_{GS} = 18V, Silicon Carbide (SiC) N-Channel MOSFET, SOT-227.



Features

- Low capacitances and low gate charge
- Fast switching speed due to low internal gate resistance (ESR)
- Stable operation at high junction temperature, T_{I(max)} = 175 °C
- Fast and reliable body diode
- Superior avalanche ruggedness
- · RoHS compliant
- Isolated voltage to 2500V, UL certified file E145592

Benefits

- High efficiency to enable lighter and more compact system
- Simple to drive and easy to parallel
- Improved thermal capabilities and lower switching losses
- Eliminates the need for external freewheeling diode
- · Lower system cost of ownership

Applications

- Photovoltaic (PV) inverter, converter, and industrial motor drives
- Smart grid transmission and distribution
- Induction heating and welding
- Hybrid Electric Vehicle (HEV) powertrain and Electric Vehicle (EV) charger
- Power supply and distribution

1. Device Specifications

This section shows the specifications of this device.

1.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings of this device.

Table 1-1. Absolute Maximum Ratings

Symbol	Parameter	Ratings	Unit
V_{DSS}	Drain source voltage	1200	V
I _D	Continuous drain current at T _C = 25 °C	34	A
	Continuous drain current at T _C = 100 °C	24	
I _{DM}	Pulsed drain current ¹	111	
V_{GS}	Gate-source voltage	23 to -10	V
	Transient gate-source voltage	25 to -12	
P _D	Total power dissipation at T _C = 25 °C	165	W
	Linear derating factor	1	W/°C

Note:

1. Repetitive rating: pulse width and case temperature are limited by the maximum junction temperature.

The following table shows the thermal and mechanical characteristics of this device.

Table 1-2. Thermal and Mechanical Characteristics

Symbol	Characteristic/Test Conditions	Min.	Тур.	Max.	Unit
$R_{\theta JC}$	Junction-to-case thermal resistance	_	0.7	0.91	°C/W
T _J	Operating junction temperature	-55	_	175	°C
T _{STG}	Storage temperature	-55	_	150	
V _{ISOLATION}	RMS voltage (50 Hz–60 Hz sinusoidal waveform from terminals to mounting base for 1 minute)	2500	_	_	V
τ_{M}	Mounting torque, M3 screw for heat sink attachment (requires 2, not included)	_	0.8	_	N·m
τ_{T}	Terminal screw torque, M4 screw (4 included)	-	_	1.1	N·m
Wt	Package weight	_	29.2	_	g

ESD practices should comply with JESD-625.

1.2 Electrical Performance

The following table shows the static characteristics of this device. T_J = 25 °C unless otherwise specified.

Table 1-3. Static Characteristics

Symbol	Characteristic	Test Conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V _{GS} = 0V, I _D = 100 μA	1200	<u> </u>	_	V
R _{DS(on)}	Drain-source on resistance ¹	V _{GS} = 20V, I _D = 15A	_	80	100	mΩ
		V _{GS} = 18V, I _D = 15A	_	90	_	
$V_{GS(th)}$	Gate-source threshold voltage	$V_{GS} = V_{DS}$, $I_D = 1 \text{ mA}$	1.9	3.0	5.0	V
$I_{\rm DSS}$	Zero gate voltage drain current	V _{DS} = 1200V, V _{GS} = 0V	_	0.2	30	μΑ
		V _{DS} = 1200V, V _{GS} = 0V, T _J = 175 °C	_	2	_	
I_{GSS}	Gate-source leakage current	V _{GS} = 20V/–10V	_	_	±100	nA

Note:

1. Pulse test: pulse width < 380 μ s, duty cycle < 2%.

The following table shows the dynamic characteristics of this device. T_J = 25 °C unless otherwise specified. The dynamic characteristics are characterized, not 100% tested, at the recommended operating V_{GS} = 20V/–5V.

Table 1-4. Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance	V _{GS} = 0V	_	1031	_	pF
C _{rss}	Reverse transfer capacitance	V _{DD} = 1000V	_	6	_	
C _{oss}	Output capacitance	$V_{AC} = 25 \text{ mV}$ f = 200 kHz	_	92	_	
Q_{G}	Total gate charge	V _{GS} = -5V/20V	_	64	<u> </u>	nC
Q _{GS}	Gate-source charge	V _{DD} = 800V	_	12	<u> </u>	
Q_{GD}	Gate-drain charge	I _D = 15A	_	19	_	
t _{d(on)}	Turn-on delay time	V _{DD} = 850V	_	14	<u> </u>	ns
t _r	Voltage rise time	$V_{GS} = -5V/20V$	_	13	<u> </u>	
t _{d(off)}	Turn-off delay time	I _D = 20A	_	19	_	
t _f	Voltage fall time	$R_{G(ext)} = 4\Omega$	_	13	_	
E _{on}	Turn-on switching energy	Freewheeling diode = MSC080SMA120J (V _{GS} = -5V);	_	350	 -	μJ
E _{off}	Turn-off switching energy	reference Figure 1-19	_	62	_	
ESR	Gate equivalent series resistance	f = 1 MHz, 25 mV, drain short	_	1.9	_	Ω
SCWT	Short circuit withstand time	$V_{DS} = 960V, V_{GS} = 20V$	_	3.0	_	μs
E _{AS}	Avalanche energy, single pulse	I _D = 15A	_	1300	_	mJ

The following table shows the body diode characteristics of this device. $T_J = 25$ °C unless otherwise specified. The body diode reverse recovery is characterized, not 100% tested.

Table 1-5. Body Diode Characteristics

Symbol	Characteristic	Test Conditions	Min.	Тур.	Max.	Unit
V_{SD}	Diode forward voltage	I _{SD} = 15A, V _{GS} = 0V	_	3.7		V
		$I_{SD} = 15A, V_{GS} = -5V$	_	3.9	5.0	
t _{rr}	Reverse recovery time	I_{SD} = 20A, V_{GS} = –5V, Drive R_G = 4Ω , V_{DD} =	_	22	_	ns
Q _{rr}	Reverse recovery charge	850V, dI/dt = -5200 A/μs	_	177	_	nC
I _{RRM}	Reverse recovery current		_	16	_	Α

1.3 Typical Performance Curves

Data for performance curves are characterized, not 100% tested.

Figure 1-1. Drain Current vs. V_{DS} at T_{J}

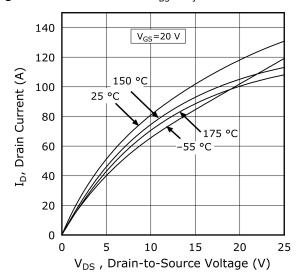


Figure 1-2. Drain Current vs. V_{DS} at V_{GS}

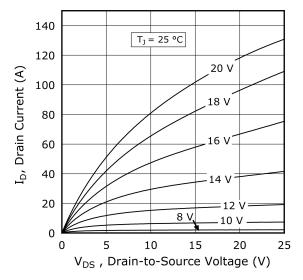


Figure 1-3. Drain Current vs. V_{DS} at V_{GS}

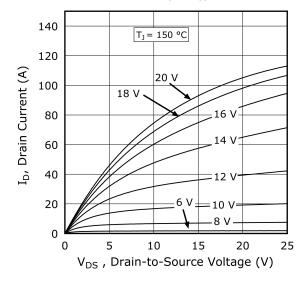


Figure 1-4. Drain Current vs. V_{DS} at V_{GS}

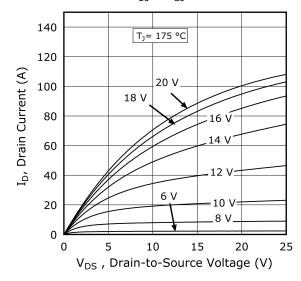


Figure 1-5. R_{DS(on)} vs. Junction Temperature

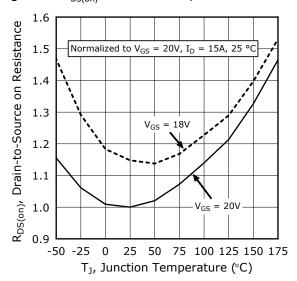


Figure 1-6. Gate Charge Characteristics

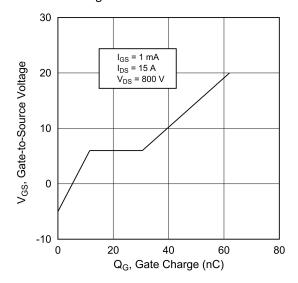


Figure 1-7. Capacitance vs. Drain-to-Source Voltage

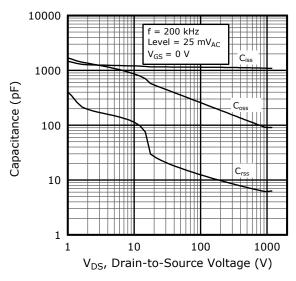


Figure 1-8. Output Charge vs. Drain-to-Source Voltage

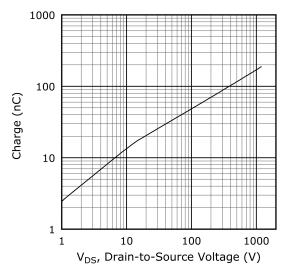


Figure 1-9. Output Stored Energy vs. V_{DS}

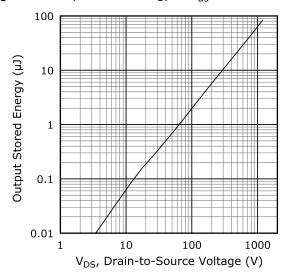


Figure 1-10. I_D vs. V_{DS} 3^{rd} Quadrant Conduction

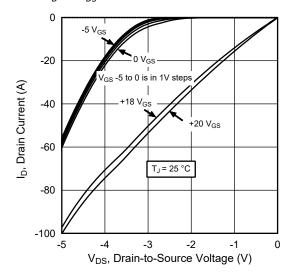


Figure 1-11. I_D vs. V_{DS} 3rd Quadrant Conduction

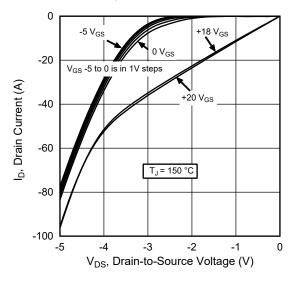


Figure 1-12. Switching Energy E_{on} vs. $V_{DS} \& I_{D}$

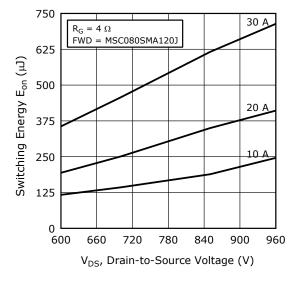


Figure 1-13. Switching Energy E_{off} vs. $V_{DS} \& I_{D}$

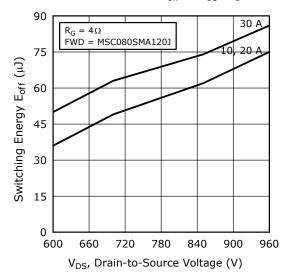


Figure 1-14. Switching Energy vs. R_G

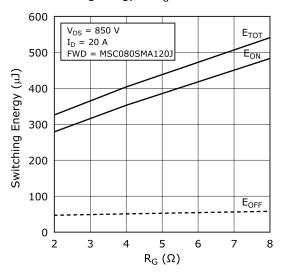


Figure 1-15. Switching Energy vs. Junction Temperature

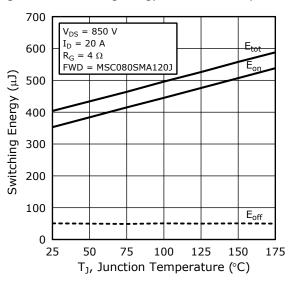


Figure 1-16. Threshold Voltage vs. Junction Temperature

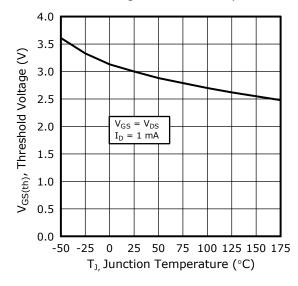


Figure 1-17. Forward Safe Operating Area

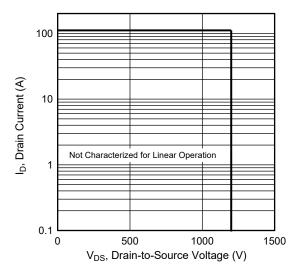
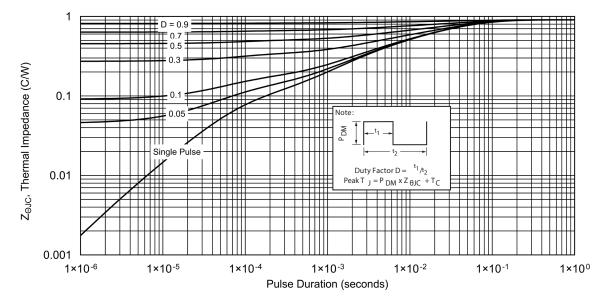
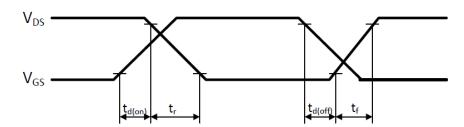


Figure 1-18. Maximum Transient Thermal Impedance



The following figure shows the switching waveform diagram of this device.

Figure 1-19. Switching Waveform



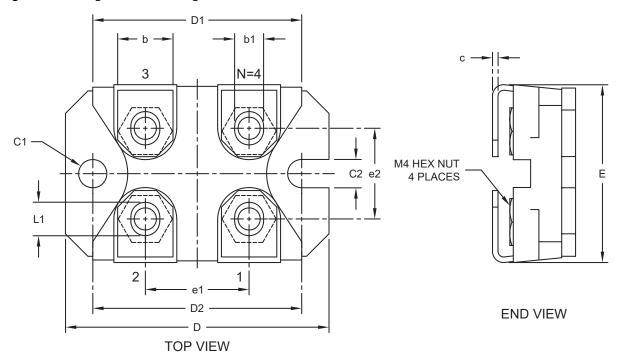
2. Package Specification

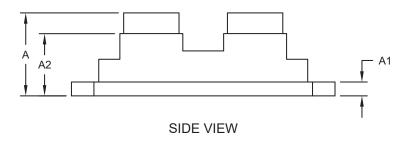
This section shows the package specification of this device.

2.1 Package Outline Drawing

The following figure illustrates the SOT-227 package outline of this device.

Figure 2-1. Package Outline Drawing





The following table shows the SOT-227 dimensions and should be used in conjunction with the package outline drawing.

Table 2-1. SOT-227 Dimensions

Symbol	Description	Min. (mm)	Max. (mm)
N	Number of terminals	4	
e1	Terminal pitch	14.90	15.10



continued				
Symbol	Description	Min. (mm)	Max. (mm)	
e2	Terminal pitch	12.60	12.88	
Α	Overall height	11.68	12.24	
A1	Base plate thickness	1.95	2.14	
A2	Molded package thickness	8.90	9.60	
D	Overall length	37.95	38.20	
D1	Molded package length	31.50	31.90	
D2	Mounting centers	30.10	30.30	
E	Overall width	25.15	25.40	
b	Terminal width	7.80	8.20	
С	Terminal thickness	0.75	0.85	
b1	Terminal slot width	4.10	4.30	
L1	Terminal slot length	4.72	4.90	
C1	Mounting hole diameter	4.00	4.29	
C2	Mounting slot width	4.00	4.29	

3. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

Table 3-1. Revision History

Revision	Date	Description
D	07/2024	The following changes are made in this revision of the document:
		• Added τ_M and τ_T symbols for mounting torque in Table 1-2
		Updated Table 2-1
С	05/2024	The following changes are made in this revision of the document:
		Added Figure 1-9.
В	08/2023	The following changes are made in this revision of the document:
		• Updated values in Table 1-3
		Updated values in Table 1-5
A	06/2021	Document migrated from Microsemi template to Microchip template; Assigned Microchip literature number DS-00004138A, which replaces the previous Microsemi literature number 050-7767.
Initial release (Microsemi Revision A)	02/2020	Document created.

Microchip Information

The Microchip Website

Microchip provides online support via our website at www.microchip.com/. This website is used to make files and information easily available to customers. Some of the content available includes:

- **Product Support** Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- **General Technical Support** Frequently Asked Questions (FAQs), technical support requests, online discussion groups, Microchip design partner program member listing
- **Business of Microchip** Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

Product Change Notification Service

Microchip's product change notification service helps keep customers current on Microchip products. Subscribers will receive email notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, go to www.microchip.com/pcn and follow the registration instructions.

Customer Support

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Embedded Solutions Engineer (ESE)
- Technical Support

Customers should contact their distributor, representative or ESE for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in this document.

Technical support is available through the website at: www.microchip.com/support

Microchip Devices Code Protection Feature

Note the following details of the code protection feature on Microchip products:

- Microchip products meet the specifications contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is secure when used in the intended manner, within operating specifications, and under normal conditions.
- Microchip values and aggressively protects its intellectual property rights. Attempts to breach the code protection features of Microchip product is strictly prohibited and may violate the Digital Millennium Copyright Act.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of its code. Code protection does not mean that we are guaranteeing the product is "unbreakable".
 Code protection is constantly evolving. Microchip is committed to continuously improving the code protection features of our products.

Legal Notice

This publication and the information herein may be used only with Microchip products, including to design, test, and integrate Microchip products with your application. Use of this information in any other manner violates these terms. Information regarding device applications is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure



that your application meets with your specifications. Contact your local Microchip sales office for additional support or, obtain additional support at www.microchip.com/en-us/support/design-help/client-support-services.

THIS INFORMATION IS PROVIDED BY MICROCHIP "AS IS". MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION INCLUDING BUT NOT LIMITED TO ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, AND FITNESS FOR A PARTICULAR PURPOSE, OR WARRANTIES RELATED TO ITS CONDITION, QUALITY, OR PERFORMANCE.

IN NO EVENT WILL MICROCHIP BE LIABLE FOR ANY INDIRECT, SPECIAL, PUNITIVE, INCIDENTAL, OR CONSEQUENTIAL LOSS, DAMAGE, COST, OR EXPENSE OF ANY KIND WHATSOEVER RELATED TO THE INFORMATION OR ITS USE, HOWEVER CAUSED, EVEN IF MICROCHIP HAS BEEN ADVISED OF THE POSSIBILITY OR THE DAMAGES ARE FORESEEABLE. TO THE FULLEST EXTENT ALLOWED BY LAW, MICROCHIP'S TOTAL LIABILITY ON ALL CLAIMS IN ANY WAY RELATED TO THE INFORMATION OR ITS USE WILL NOT EXCEED THE AMOUNT OF FEES, IF ANY, THAT YOU HAVE PAID DIRECTLY TO MICROCHIP FOR THE INFORMATION.

Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights unless otherwise stated.

Trademarks

The Microchip name and logo, the Microchip logo, Adaptec, AVR, AVR logo, AVR Freaks, BesTime, BitCloud, CryptoMemory, CryptoRF, dsPIC, flexPWR, HELDO, IGLOO, JukeBlox, KeeLoq, Kleer, LANCheck, LinkMD, maXStylus, maXTouch, MediaLB, megaAVR, Microsemi, Microsemi logo, MOST, MOST logo, MPLAB, OptoLyzer, PIC, picoPower, PICSTART, PIC32 logo, PolarFire, Prochip Designer, QTouch, SAM-BA, SenGenuity, SpyNIC, SST, SST Logo, SuperFlash, Symmetricom, SyncServer, Tachyon, TimeSource, tinyAVR, UNI/O, Vectron, and XMEGA are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

AgileSwitch, ClockWorks, The Embedded Control Solutions Company, EtherSynch, Flashtec, Hyper Speed Control, HyperLight Load, Libero, motorBench, mTouch, Powermite 3, Precision Edge, ProASIC, ProASIC Plus, ProASIC Plus logo, Quiet-Wire, SmartFusion, SyncWorld, TimeCesium, TimeHub, TimePictra, TimeProvider, and ZL are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Adjacent Key Suppression, AKS, Analog-for-the-Digital Age, Any Capacitor, Anyln, AnyOut, Augmented Switching, BlueSky, BodyCom, Clockstudio, CodeGuard, CryptoAuthentication, CryptoAutomotive, CryptoCompanion, CryptoController, dsPICDEM, dsPICDEM.net, Dynamic Average Matching, DAM, ECAN, Espresso T1S, EtherGREEN, EyeOpen, GridTime, IdealBridge, IGaT, In-Circuit Serial Programming, ICSP, INICnet, Intelligent Paralleling, IntelliMOS, Inter-Chip Connectivity, JitterBlocker, Knob-on-Display, MarginLink, maxCrypto, maxView, memBrain, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mSiC, MultiTRAK, NetDetach, Omniscient Code Generation, PICDEM, PICDEM.net, PICkit, PICtail, Power MOS IV, Power MOS 7, PowerSmart, PureSilicon, QMatrix, REAL ICE, Ripple Blocker, RTAX, RTG4, SAM-ICE, Serial Quad I/O, simpleMAP, SimpliPHY, SmartBuffer, SmartHLS, SMART-I.S., storClad, SQI, SuperSwitcher, SuperSwitcher II, Switchtec, SynchroPHY, Total Endurance, Trusted Time, TSHARC, Turing, USBCheck, VariSense, VectorBlox, VeriPHY, ViewSpan, WiperLock, XpressConnect, and ZENA are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

The Adaptec logo, Frequency on Demand, Silicon Storage Technology, and Symmcom are registered trademarks of Microchip Technology Inc. in other countries.

GestIC is a registered trademark of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.



All other trademarks mentioned herein are property of their respective companies.

© 2024, Microchip Technology Incorporated and its subsidiaries. All Rights Reserved.

ISBN: 978-1-6683-0077-0

Quality Management System

For information regarding Microchip's Quality Management Systems, please visit www.microchip.com/quality.



Worldwide Sales and Service

AMERICAS	ASIA/PACIFIC	ASIA/PACIFIC	EUROPE
Corporate Office	Australia - Sydney	India - Bangalore	Austria - Wels
2355 West Chandler Blvd.	Tel: 61-2-9868-6733	Tel: 91-80-3090-4444	Tel: 43-7242-2244-39
Chandler, AZ 85224-6199	China - Beijing	India - New Delhi	Fax: 43-7242-2244-393
el: 480-792-7200	Tel: 86-10-8569-7000	Tel: 91-11-4160-8631	Denmark - Copenhagen
ax: 480-792-7277	China - Chengdu	India - Pune	Tel: 45-4485-5910
echnical Support: www.microchip.com/support	Tel: 86-28-8665-5511	Tel: 91-20-4121-0141	Fax: 45-4485-2829
Veb Address:	China - Chongqing	Japan - Osaka	Finland - Espoo
ww.microchip.com	Tel: 86-23-8980-9588	Tel: 81-6-6152-7160	Tel: 358-9-4520-820
ıtlanta	China - Dongguan	Japan - Tokyo	France - Paris
Ouluth, GA	Tel: 86-769-8702-9880	Tel: 81-3-6880- 3770	Tel: 33-1-69-53-63-20
el: 678-957-9614	China - Guangzhou	Korea - Daegu	Fax: 33-1-69-30-90-79
ax: 678-957-1455	Tel: 86-20-8755-8029	Tel: 82-53-744-4301	Germany - Garching
ustin, TX	China - Hangzhou	Korea - Seoul	Tel: 49-8931-9700
el: 512-257-3370	Tel: 86-571-8792-8115	Tel: 82-2-554-7200	Germany - Haan
oston	China - Hong Kong SAR	Malaysia - Kuala Lumpur	Tel: 49-2129-3766400
estborough, MA	Tel: 852-2943-5100	Tel: 60-3-7651-7906	Germany - Heilbronn
el: 774-760-0087	China - Nanjing	Malaysia - Penang	Tel: 49-7131-72400
ax: 774-760-0088	Tel: 86-25-8473-2460	Tel: 60-4-227-8870	Germany - Karlsruhe
hicago	China - Qingdao	Philippines - Manila	Tel: 49-721-625370
asca, IL	Tel: 86-532-8502-7355	Tel: 63-2-634-9065	Germany - Munich
el: 630-285-0071 ax: 630-285-0075	China - Shanghai	Singapore	Tel: 49-89-627-144-0
ax. 030-203-0073	Tel: 86-21-3326-8000	Tel: 65-6334-8870	Fax: 49-89-627-144-44
addison, TX	China - Shenyang	Taiwan - Hsin Chu	Germany - Rosenheim
el: 972-818-7423	Tel: 86-24-2334-2829	Tel: 886-3-577-8366	Tel: 49-8031-354-560
ax: 972-818-2924	China - Shenzhen	Taiwan - Kaohsiung	Israel - Hod Hasharon
etroit	Tel: 86-755-8864-2200	Tel: 886-7-213-7830	Tel: 972-9-775-5100
ovi, MI	China - Suzhou	Taiwan - Taipei	Italy - Milan
el: 248-848-4000	Tel: 86-186-6233-1526	Tel: 886-2-2508-8600	Tel: 39-0331-742611
ouston, TX	China - Wuhan	Thailand - Bangkok	Fax: 39-0331-466781
el: 281-894-5983	Tel: 86-27-5980-5300	Tel: 66-2-694-1351	Italy - Padova
dianapolis	China - Xian	Vietnam - Ho Chi Minh	Tel: 39-049-7625286
oblesville, IN	Tel: 86-29-8833-7252	Tel: 84-28-5448-2100	Netherlands - Drunen
el: 317-773-8323	China - Xiamen	101. 04 20 3440 2100	Tel: 31-416-690399 Fax: 31-416-690340
ax: 317-773-5453	Tel: 86-592-2388138		Norway - Trondheim
el: 317-536-2380	China - Zhuhai		Tel: 47-72884388
os Angeles	Tel: 86-756-3210040		Poland - Warsaw
ission Viejo, CA el: 949-462-9523	161.00-730-3210040		Tel: 48-22-3325737
ax: 949-462-9608			Romania - Bucharest
el: 951-273-7800			Tel: 40-21-407-87-50
aleigh, NC			
el: 919-844-7510			Spain - Madrid Tel: 34-91-708-08-90
ew York, NY			Fax: 34-91-708-08-90
el: 631-435-6000			Sweden - Gothenberg
an Jose, CA			Tel: 46-31-704-60-40
el: 408-735-9110			Sweden - Stockholm
el: 408-436-4270			Tel: 46-8-5090-4654
anada - Toronto			UK - Wokingham
el: 905-695-1980			Tel: 44-118-921-5800
ax: 905-695-2078			Fax: 44-118-921-5820